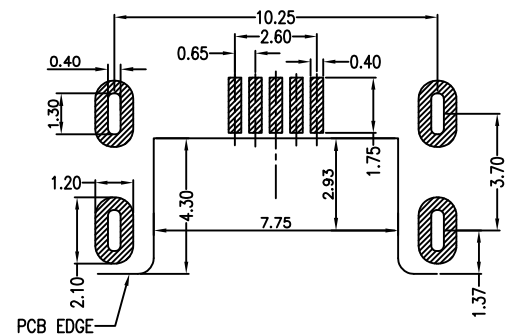
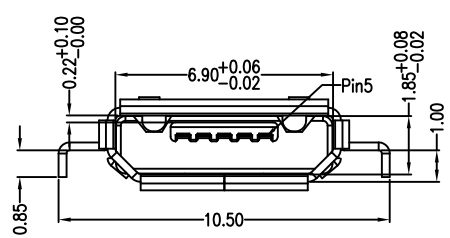
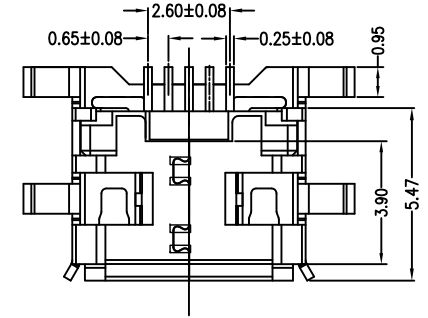
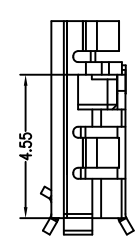
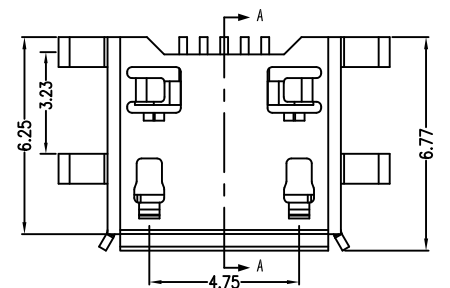
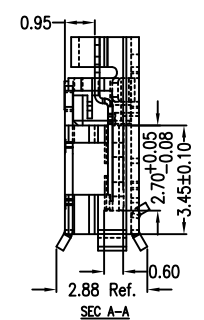
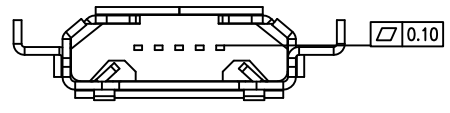


RoHS

MAPX	MODIFICATION	DRW	DATE



- Note:
- Material:
    - Housing: High temperature thermoplastic with g.f,UL94v-0
    - Contact: copper alloy,t=0.15mm
    - Shell: copper alloy,t=0.25mm
  - Specification:
    - Current rating:1,5PIN 1.8A Max/2,3,4PIN 1A Max.
    - Dielectric withstanding voltage: 100 V(ac) for 1 min.
    - Contact resistance: 30 mΩ Max.
    - Insulation resistance: 100 MΩ Min.
    - Total mating force: 3.57 Kgf Max.
    - Total unmating force: 1.0 Kgf Min.
    - Temperature range: -30°C~80°C

RECOMMENDED PCB LAYOUT  
PCB图仅供参考

产品图 PRODUCT CHART DWG		深圳市精拓金电子有限公司 Shenzhen Jing Tuo Jin Electronics Co., Ltd.							
公差一览表 TOLERANCE UNLESS OTHERWISE				单位 UNITS	MM	制图 DRAWING	XZQ	制图料号 PRODUCT PART NO.	920-F52A2021S10108
X.	±0.25	X.	±5.°	比例 SCALE	1:1	审核 CHKD	郭志富	产品名称 PRODUCT NO.	MICRO/5S B型沉板式1.0四脚插板 有边单卡点无孔SMT无接地片
.X	±0.20	.X	±2.°	日期 DATE	2016-09-09	核准 APPD	黄国荣	角法 VIEW	版本 VER
.XX	±0.15	.XX	±1.°						AO
.XXX	±0.10	.XXX	±0.5°						

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